## OCT 18 2005

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

in Re Application of:	)
. Wu et al.	) Group Art Unit: 2891
Serial No.: 10/672,778	) Examiner: Smith, Bradley
Filed: September 26, 2003	) Confirmation No.: 9717
For: Atomic Layer Deposition (ALD Enhanced Deposition Rate	Method with ) TKHR Docket: 252016-3000 ) Top-Team: 0503-8501DUS )
I hereby certify that this paper (along with any paper)	TLE TRANSMISSION UNDER 37 CFR § 1.8 or referred to as being attached or enclosed) is being transmitted ited States Patent and Trademark Office, Technology Group of pages in this transmission.  Hui Chim Barnhill

## RESPONSE TO RESTRICTION/ELECTION REQUIREMENTS

Mail Stop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, Virginia 22313-1450

Sir:

The Office Action mailed September 22, 2005 has been carefully considered. In further response thereto, please enter the following amendments and consider the following remarks.

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